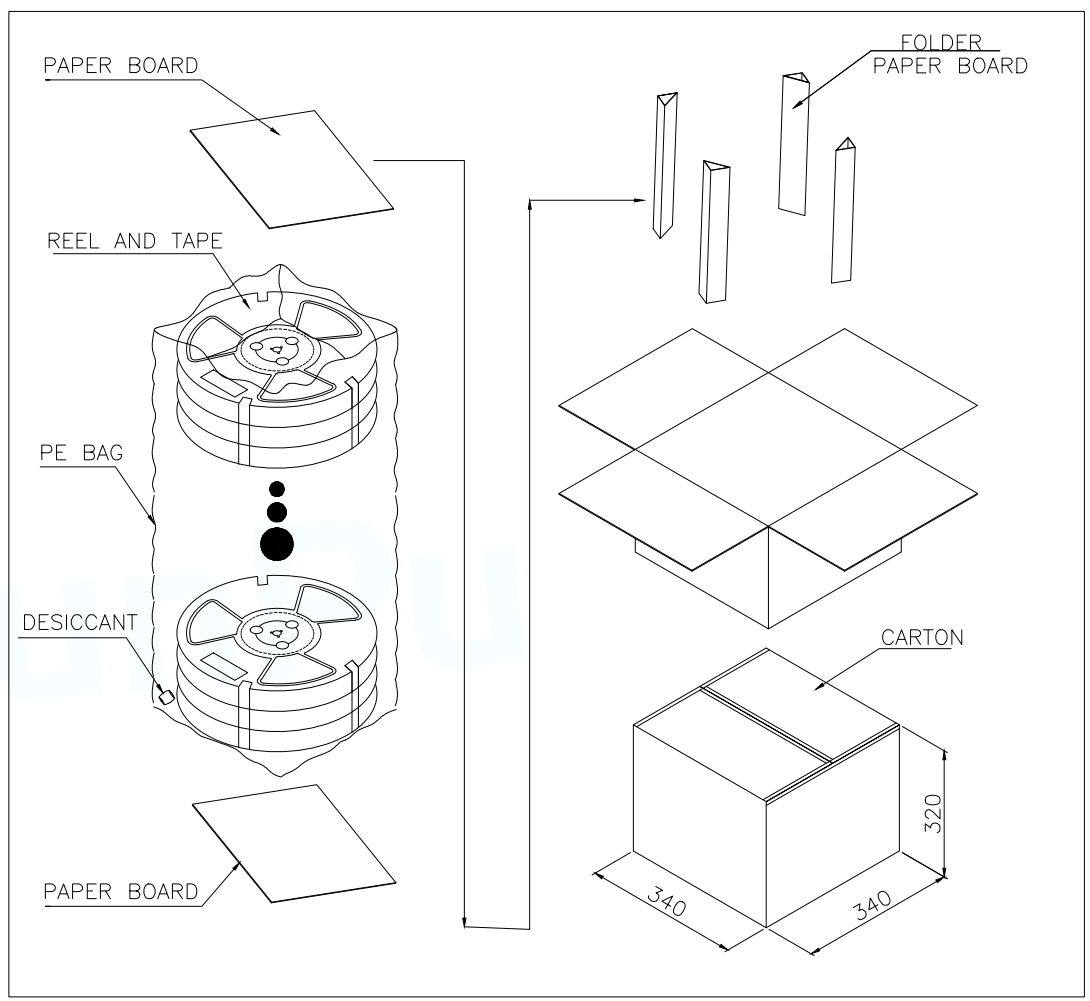
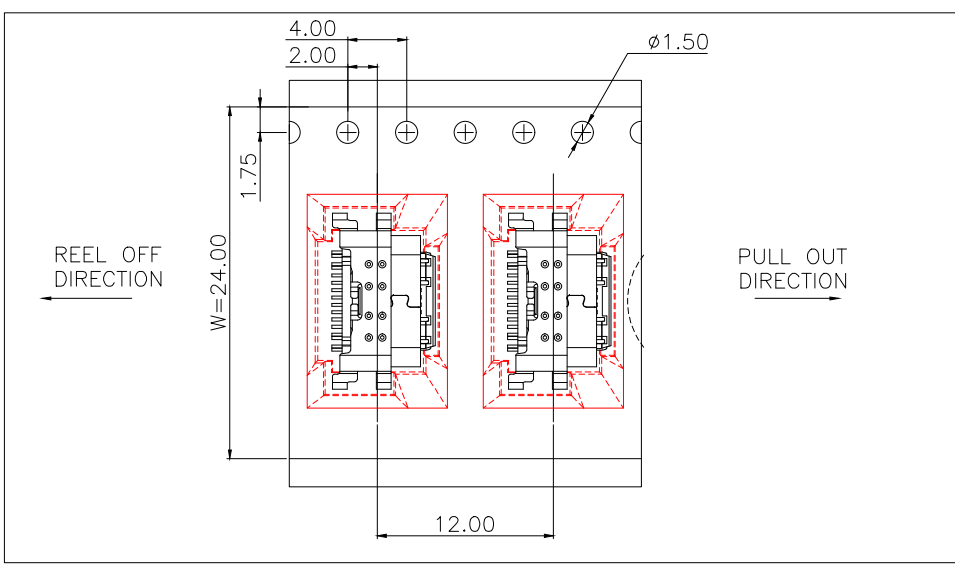
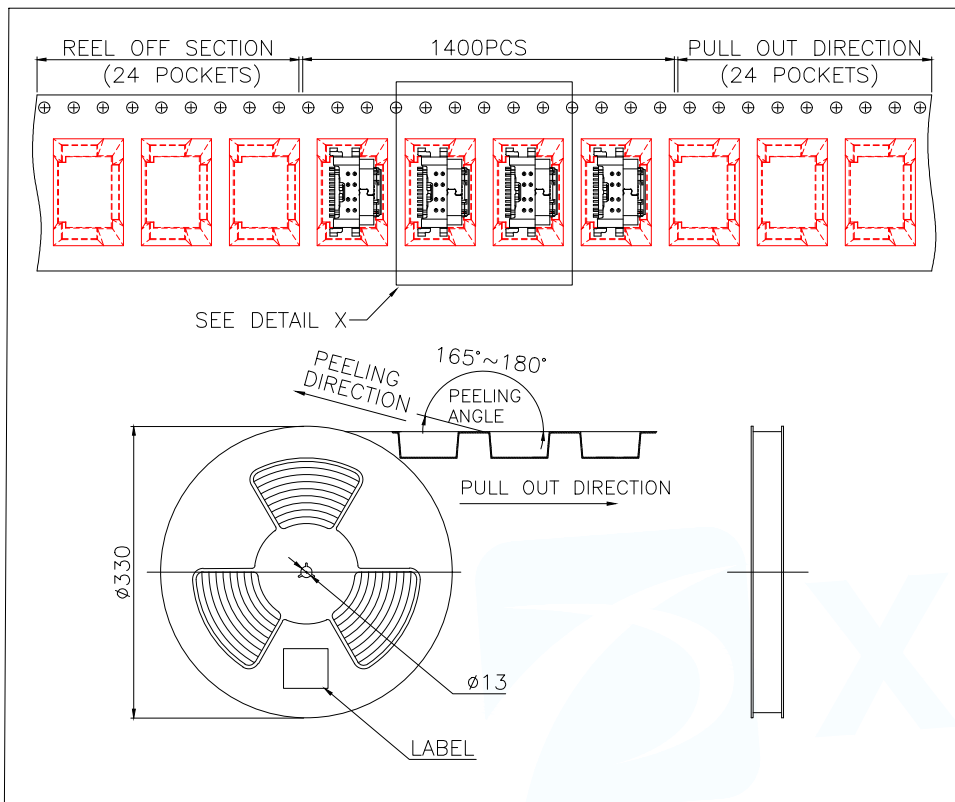


NOTE:

- MATERIAL SPECIFICATION:
  - HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.(PA9T)
  - TERMINAL: COPPER ALLOY(C18150)
  - MID PLATE: STAINLESS STEEL(SUS301)
  - INNER SHELL: STAINLESS STEEL(SUS304)
  - COVER SHELL: STAINLESS STEEL(SUS304)
- PLATING SPECIFICATION:
  - TERMINAL:
    - Ni 50u" MIN. UNDER PLATED OVER ALL.
    - Au 3u" PLATED ON THE FUNCTIONAL AREA OF CONTACT.
    - Au G/F ON THE SOLDER AREA OF CONTACT.
  - INNER SHELL&COVER SHELL:
    - Ni 30u" MIN. UNDER PLATED OVER ALL.
  - MID PLATE:
    - CLEAR ONLY
- MECHANICAL PERFORMANCE,
  - INSERTION FORCE: 0.5~2.0kgf.
  - REMOVAL FORCE: 0.8kgf~2.0kgf.
  - DURABILITY: 10000 CYCLES.
- ELECTRICAL PERFORMANCE,
  - VOLTAGE RATING: 5V  
CURRENT RATING: 5A
  - LLCR:
    - VBUS & GND PINS AND OTHER PINS: 40mA/PIN MAX.
    - LLCR MAX. CHANGE OF ALL PINS: 10mA.
  - INSULATION RESISTANCE: 100MΩ MIN
  - DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
- ENVIRONMENTAL PERFORMANCE:
  - OPERATING TEMPERATURE: -40°C~+85°C.
- IR REFLOW:
  - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:USB CF 16PIN (L=7.0) SINK 1.6MM WITH COVER
			PAR TYPE-C-633-WFRSC160
DECIMALS:	ANGLES:	CUSTOMER COPY SIZE:A4 SHEET:1F3 REV:A	DWN Lucas
.X:±0.30	X.':±10'		CHKD Ethan
.XX:±0.20	X.X':±8'		APVD Jacob
.XXX:±0.10	X.XX':±5'		SCALE:1:1 UNIT:MM





		REEL	CARTON
CONNECTOR (PCS)		1400	14000
MANUFACTURE DWG	东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE:USB CF 16PIN (L=7.0) SINK 1.6MM WITH COVER	
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.XXX:±0.10	X.XX':±5°	SCALE:1:1	UNIT:MM
	CUSTOMER COPY	SIZE:A4	SHEET:3F3
			REV:A